

OCT-11-2006 WED 16:29

RECEIVED
CENTRAL FAX CENTER

FAX NO.

P. 01

Patent

OCT 11 2006

Customer No.: 31561
Docket No. 11579-US-PA
Application No.: 10/710,419

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Applicant : Min-Lung Huang
Application No. : 10/710,419
Filed : July 9, 2004
For : WAFER STRUCTURE AND BUMPING PROCESS
THEREOF
Art Unit : 2814
Examiner : MAI, ANH D.

TRANSMITTAL LETTER
+1-571-273-8300 (Via Fax: 2+8 pages)

Assistant Commissioner for Patents
Alexandria, VA 22314

Dear Sir,

In response to the Office Action dated July 14, 2006 (Paper No.:20060710), transmitted herewith please find the Response in (8) pages.

The Applicant is NOT entitled to a status as a Small Entity; accordingly, please charge the following fees to the Deposit Account No.: 50-2620 (Order No.: 11579-US-PA),

Fees are calculated as follows:

<input type="checkbox"/> Extra Claims Fee :					
	NUMBER FILED	CLAIMS FILED PRESENT HIGHEST NO. EXTRA PREVIOUSLY PAID FOR	RATE	FEE	
Total Claims	13	MINUS 22 = 0	x \$ 50	= \$ 0/	
Independent Claims	1	MINUS 2 = 0	x \$ 200	= \$ 0/	
<input type="checkbox"/> [1/2/3] month(s) extension of time is hereby requested.				= \$ 0/ 120/ 450/ 1020	
<input type="checkbox"/> Terminal Disclaimer Fee				= \$ 0/ 130	
<input type="checkbox"/> Fee regarding Submission of an Information Disclosure Statement .				= \$ 0/ 180	
			Total:	= \$ 0	

If the payment is not fully covered in response thereof, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No.: 50-2620 (Order No.: 11579-US-PA).

Patent

Customer No.: 31561
Docket No. 11579-US-PA
Application No.: 10/710,419

Thank you for your assistance in the subject matter. If you have any questions, please feel free to contact me.

Respectfully Submitted,
JIANQ CHYUN Intellectual Property Office

Date: Oct. 11, 2006

By: Belinda Lee
Belinda Lee
Registration No.: 46,863

Please send future correspondence to:
7F. -1, No. 100, Roosevelt Rd.,
Sec. 2, Taipei 100, Taiwan, R.O.C.
Tel: 886-2-2369 2800 Fax: 886-2-2369 7233 / 886-2-2369 7234
E-MAIL: BELINDA@JCIPGroup.com.tw; USA@JCIPGroup.com.tw

**RECEIVED
CENTRAL FAX CENTER**

OCT 11 2006

Customer No.: 31561
Docket No.: 11579-US-PA
Application No.: 10/710,419

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Examiner: MAI, Anh D.

Group Art Unit: 2814

In re PATENT APPLICATION of
Applicants : HUANG, Min-Lung

)

)

Serial No. : 10/710,419

)

)

AMENDMENT

Filed : July 9, 2004

)

)

For : Wafer Structure And Bumping
Process Thereof

)

)

) Attorney Docket: 11579-US-PA

)

The Commissioner is authorized to charge any fees required in connection with the
filing of this paper to account No. 50-2620 (Order No.: 11579-US-PA)

AMENDMENTS AND RESPONSE TO OFFICE ACTION

United States Patent and Trademark Office
Customer Service Window
Mail Stop Amendment
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Dear Sir:

The Office Action dated July 14, 2006, has been carefully considered. In response thereto,
please enter the following amendments and consider the following remarks.